



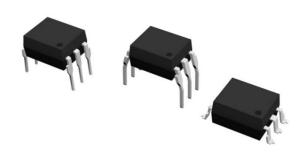
HT series

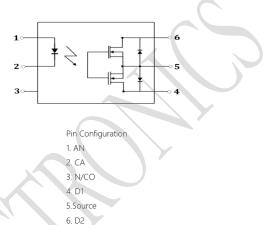
Photo Coupler Product Specification

HT6-21X



■ Package





Description

The HT6-21X is solid state relays containing an AlGaAs infrared LEDs on the light emitting side (input side) optically coupled to a high voltage output detector circuit. The detector consists of a photovoltaic diode array and MOSFETs on the output side. The single channel configuration is equivalent to 1 form A EMR. The devices in a 6-pin small outline SMD package.

■ Features

- Normally open signal pole signal throw relay
- Low operating current
- 60 to 600V output withstand voltage
- Wide operating temperature range of -40°C to 85°C
- High input-output isolation voltage(Viso = 5,000Vrms)
- Safety approval (UL 1577, VDE DIN EN60747-5-5 (VDE 0884-5), CQC11-471543-2022)
- RoHS
- MSL1

Applications

- Measurement equipment
- Exchange equipment
- FA/OA equipment
- Security
- Industrial controls



■ Product Nomenclature

The product name is designated as below:

HT6 -21X -X X- X X- XX

1 2 3 4

Designation:

HT =Hengtuo Technology Co.,LTD.

6 = Dip 6 Package type

21X= Product Series(212,213,214,216)

- ① = Lead form option(S1,M,NONE)₍₁₎
- 2 = Tape and Reel option(TP,TP1,NONE)(2)
- ③ = VDE order option(fixed code "V")
- ④ = Halogen free option(fixed code"G")
- ⑤ = Customer code

Notes

1. Lead form option:

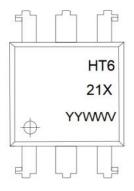
Symbol	Description
S1	DIP4-S1
М	DIP4-M
NONE	DIP4 Normal

2. Tape and Reel option:

Symbol	Description
TP&TP1	Tape and Reel Type
NONE	DIP Type



■ Marking Information



Designation:

HT denotes Hengtuo
6 denotes Dip 6 Package type
21X denotes Device
YY denotes year code
WW denotes week code
V denotes VDE

Maximum Ratings

	Parameter	Symbol	Values	Unit
	Forward Current	l _E	50	mA
	Reverse Voltage	V _R	6	V
	Power Dissipation	Р	75	MW
Input	Peak Forward Current (100µs pulse, 100Hz)	lep	1	Α
	Thermal Resistance Junction-Ambient	$R_{ ext{thJ-A}}$	325	°C/W
	Thermal Resistance Junction-Case	R_{thJ-C}	200	°C/W
	Break Down Voltage		HT6-212 60	
		V_L	HT6-213 100	V
			HT6-214 400	
			HT6-216 600	
	Continuous Load Current	lι	HT6-212 550	
Output			HT6-213 180	mA
Output			HT6-214 120	IIIA
	<u>Y</u>		HT6-216 50	
			HT6-212 1.2	
	Pulse Load Current*(1)	lin i	HT6-213 0.5	Α
	Pulse Load Current	I LPeak	HT6-214 0.3	^
			HT6-216 0.15	
Power Dis	sipation	P _{out}	500	mW
Operating	temperature range	T_{op}	− 40 ~ 85	°C



Storage temperature range	T_{stg}	− 40 ~ 125	°C
Total Power consumption	P(W)	550	mW
Isolation Voltage ⁽²⁾	V _{ISO}	5000	Vrms
Soldering Temperature ⁽³⁾	T_{SOL}	260	°C

Notes:

(1). A connection: 100ms (1 shot), VL = DC

(2)AC for 1 minute, R.H.= $40 \sim 60\%$ R.H. In this test, pins 1, 2 are shorted together, and pins 3, 4 are shorted together.

(3).For 10 seconds

■ Electronic Optical Characteristics

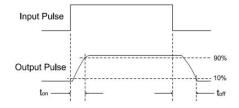
 $(TA = 25^{\circ}C)$

	Parai	mete	er	Symb ol	Min.	Тур.	Max.	Unit	Conditon
Input	Forward	d Volta	age	V _F	-	1.2	1.5	V	I _F =10mA
Imput	Reverse	e Curr	ent	lR	\ - \	-	1	μΑ	V _R =5V
	Off State leakage Current		I _{leak}	-	-	1	μA	I _F =0mA, V∟=Max	
			HT6-212		-	0.7	2.5		
	On	,	HT6-213		-	6.5	15		$I_F=10\text{mA}, I_L=$
	Resistan	stance HT6-214	$-R_{d(ON)}$	-	20	30	- Ω	Max. t = 1s	
Output	4		HT6-216		-	40	70	•	
	Output Capacit		HT6-212		-	80	-	- - pF -	VL = 0V, f = 1MHz
1		Output Capacitance -	HT6-213	- C _{out} -	-	60	-		
4			HT6-214		-	45	-		
			HT6-216	-	-	30	-		
Transfer Characteristics		LED Curre	turn on ent	IF _(on)		2.5	5	mA	IL = Max.
		LED curre	turn off nt	$IF_{(off)}$	0.4	2.5	-	mA	IL = Max.
Turn O	a Tima	Н	T6-212	т	_	1.4	3		IF = 10 mA,
Turn Oı	i iime	me HT6-213		- T _{ON} -	-	1.2	3	- ms	IL = Max. RL = 200Ω ,



HENGTUOEL	ECTRONICS					
	HT6-214	_	-	0.4	3	
	HT6-216		-	1.4	3	
Turn Off Time	HT6-212	Toff	-	0.05	0.5	_
	HT6-213		-	0.05	0.5	
	HT6-214		-	0.05	0.5	
	HT6-216	-	-	0.05	0.5	

Turn on/Turn off Time



■ Characteristics Curves



Fig.1 LED Dropout Voltage vs. Ambient Temperature

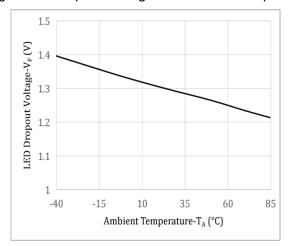


Fig.3 On Resistance vs. Ambient

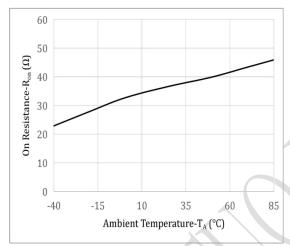


Fig.5 LED Operate Current vs. Ambient Temperature

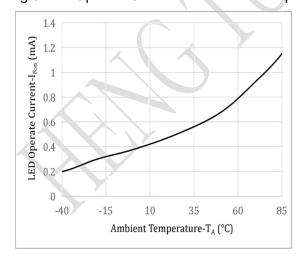


Fig.7 Turn On Time vs. Ambient Temperature

Fig.2 Output Current vs. Output Voltage

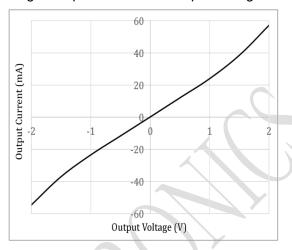


Fig.4 Load Current vs. Ambient Temperature

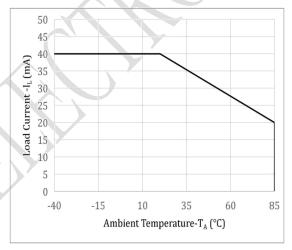


Fig.6 LED Turn Off Current vs. Ambient

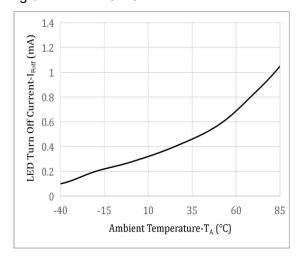


Fig.8 Turn Off Time vs. Ambient Temperature



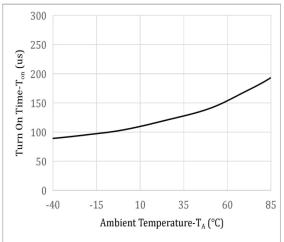


Fig.9 Turn On Time vs. LED Forward Current

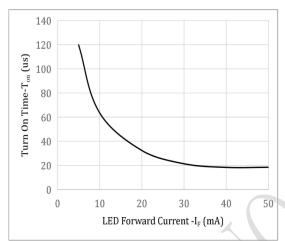
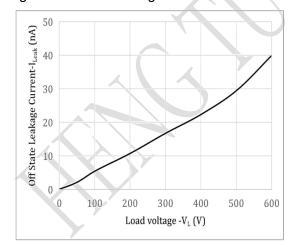


Fig.11 Off State Leakage Current vs Load Voltage



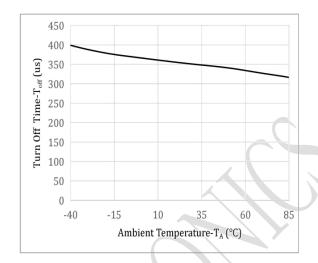
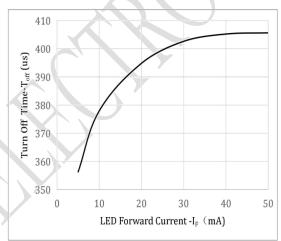


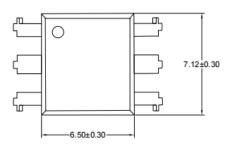
Fig.10 Turn Off Time vs. LED Forward

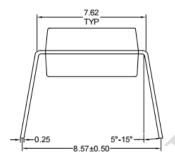


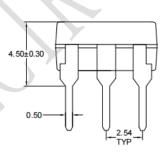


■ Outline Dimension

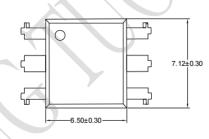
DIP Normal Type:

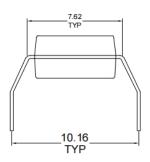


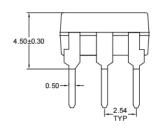




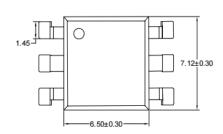
DIP M Type:

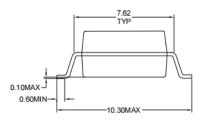


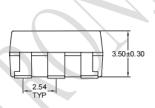










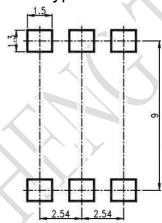


Unit: mm

Tolerance: ±0.1mm

■ Recommended solder pad Design

For S1 type:



Unit: mm

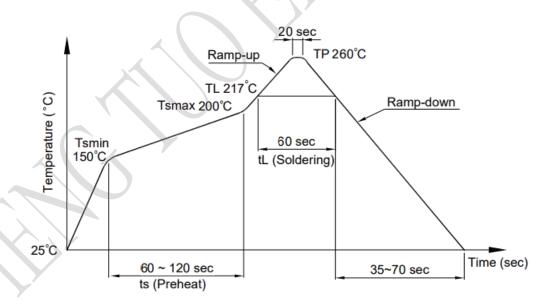
Tolerance: ±0.1mm



■ Temperature Profile Of Soldering

1. IR Reflow soldering (JEDEC-STD-020 compliant)

Profile item	Conditon
Preheat -Temperature Min (TSmin) -Temperature Max (TSmax) -Time (min to max) (ts) Soldering zone	150°C 200°C 90±30 sec
-Temperature (TL) -Time (tL)	217°C 60 sec
Peak Temperature (TP)	260°C
Ramp-up rate	3°C / sec max
Ramp-down rate	3~6°C/ sec

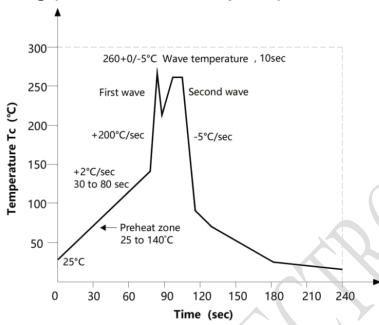


Notes:

One time soldering reflow is recommended within the condition of temperature and time profile shown below. Do not solder more than three times.



2. Wave soldering (JEDEC22A111 compliant)



3. Hand soldering by soldering iron

Allow single lead soldering in every single process. One time soldering is recommended.

Temperature: 380+0/-5°C

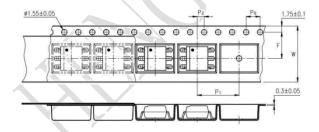
Time: 3 sec max.

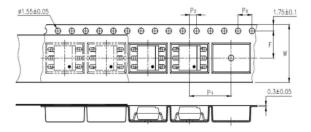
■ Packing

1. Tape and Reel

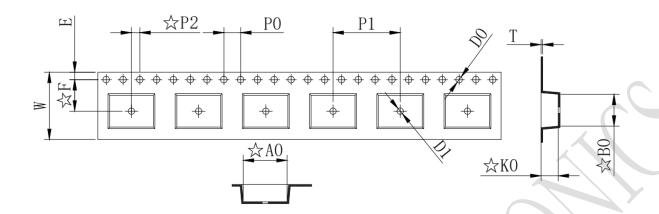
Option TA:

Option TA1:









Deminsion/mm	W	E	F	P0	P1	P2
Packagetype:S	16±0.2	1.75±0.1	7.5±0.1	4±0.1	16±0.1	2±0.1

Deminsion/mm	A0	В0	D0	D1	K0
Packagetype:S	10.45±0.1	7.6±0.1	1.5±0.1	1.5±0.1	4.1±0.1

2. Tape and Tube

Package type:Norm	al&M Tube	Outer carton
QTY/PCS	66	3.3K(50 tubes)



■ Attention:

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- The products shown in this publication are designed for the general use in electronic applications such as office automation equipment, communications devices, audio/visual equipment, electrical application and instrumentation.
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